

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +100°C	Ι _D	-5.2 -3.7	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-35	А		
Maximum Continuous Body Diode Forward Current (Note 6)			ls	-2.0	A
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	-25	A
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	33	mJ

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	103	°C/W
	t<10s	$R_{ extsf{ heta}JA}$	64	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	Р	75	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ extsf{ heta}JA}$	47	
Thermal Resistance, Junction to Case (Note 6)		R _{0JC}	13	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	С°

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

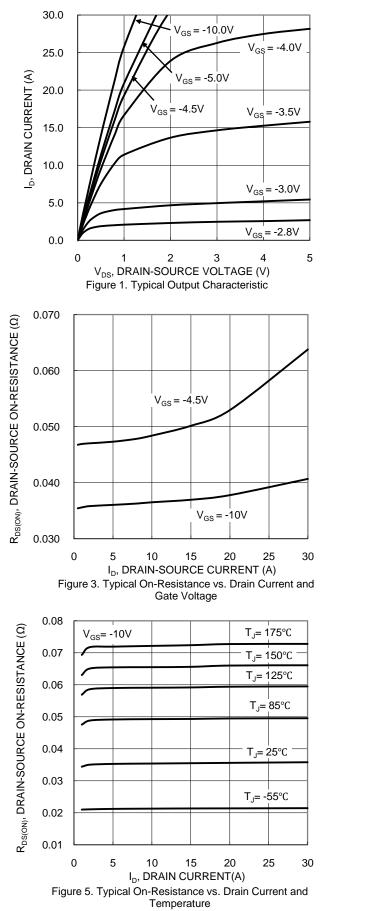
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	тур	IVIAA	Unit	Test condition	
Drain-Source Breakdown Voltage	BV _{DSS}	-60	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS			-1	μA	$V_{DS} = -60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}			±100	nA	$V_{GS} = \pm 20V, V_{GS} = 0V$	
ON CHARACTERISTICS (Note 8)	IGSS			100	1173	VGS = ±200, VDS = 00	
Gate Threshold Voltage	V _{GS(TH)}	-1.0	_	-3.0	V	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		_	34	48	mΩ	$V_{GS} = -10V, I_D = -5A$	
	R _{DS(ON)}		44	60		$V_{GS} = -4.5V, I_D = -4A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)						·	
Input Capacitance	Ciss	—	1525	—	pF		
Output Capacitance	Coss	—	90	—	pF	V _{DS} = -30V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	—	70	—	pF		
Gate Resistance	Rq	—	16	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qq	—	14.5	—	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	—	30.6	—	nC		
Gate-Source Charge	Q _{qs}	—	4.9	—	nC	$V_{DS} = -30V, I_D = -5A$	
Gate-Drain Charge	Q _{qd}	—	5.2	—	nC	1	
Turn-On Delay Time	t _{D(ON)}	—	5.3	—	ns	1	
Turn-On Rise Time	t _R	—	15.4	—	ns	$V_{GS} = -10V, V_{DS} = -30V,$	
Turn-Off Delay Time	t _{D(OFF)}	—	79.2	—	ns	$R_G = 3\Omega, I_D = -5A$	
Turn-Off Fall Time	t _F	—	45.3	—	ns		
Body Diode Reverse Recovery Time	t _{RR}	—	15.2	—	ns	I _F = -5A, di/dt = -100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	—	9.3	_	nC	I _F = -5A, di/dt = -100A/µs	

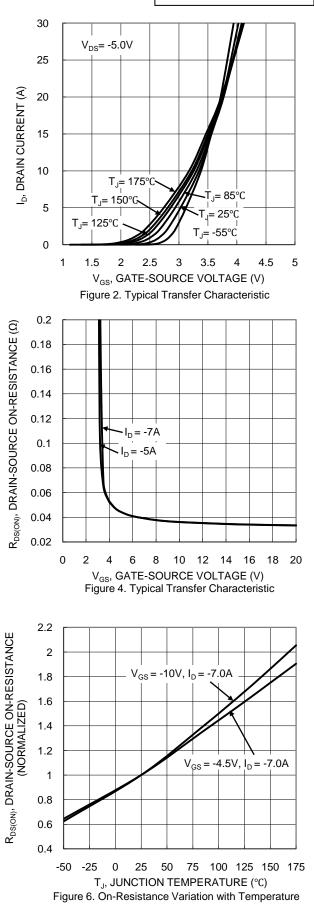
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.



DMPH6050SSD

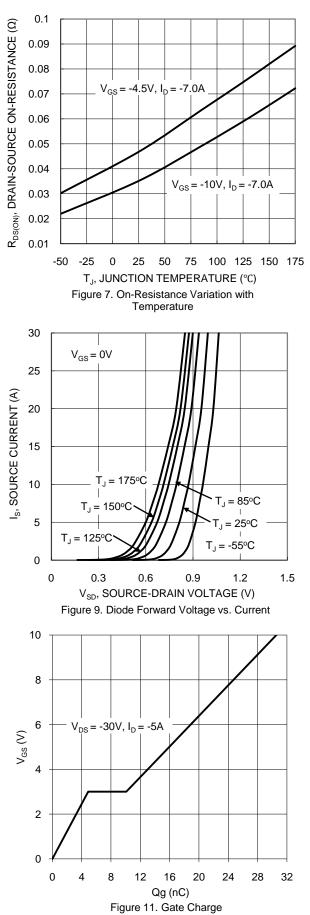


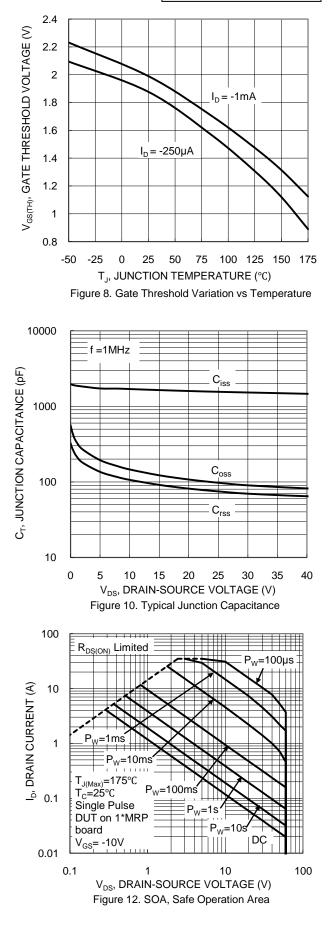


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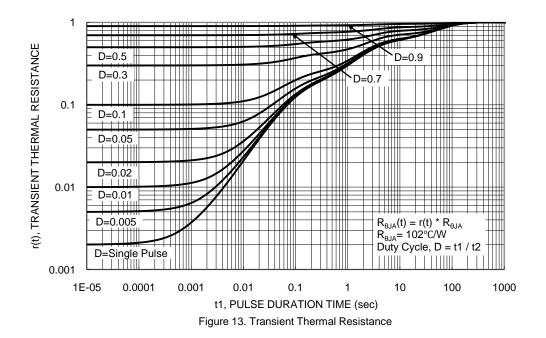
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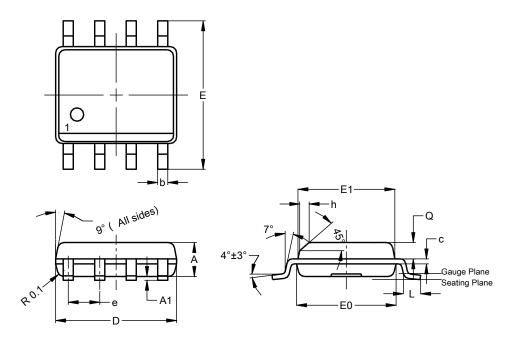




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

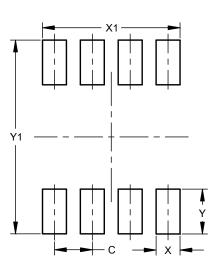
SO-8



SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
C	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
e			1.27			
h	-		0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

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